



1 pC Charge Injection, 100 pA Leakage, CMOS ± 5 V/+5 V/+3 V Quad SPST Switches

ADG611/ADG612/ADG613

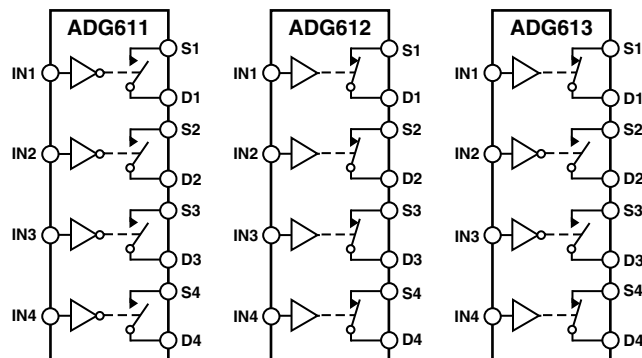
FEATURES

- 1 pC Charge Injection
- ± 2.7 V to ± 5.5 V Dual Supply
- +2.7 V to +5.5 V Single Supply
- Automotive Temperature Range -40°C to $+125^{\circ}\text{C}$
- 100 pA Max @ 25°C Leakage Currents
- 85 Ω On-Resistance
- Rail-to-Rail Switching Operation
- Fast Switching Times
- 16-Lead TSSOP Packages
- Typical Power Consumption (<0.1 μW)
- TTL/CMOS-Compatible Inputs

APPLICATIONS

- Automatic Test Equipment
- Data Acquisition Systems
- Battery-Powered Systems
- Communication Systems
- Sample and Hold Systems
- Audio Signal Routing
- Relay Replacement
- Avionics

FUNCTIONAL BLOCK DIAGRAMS



SWITCHES SHOWN FOR A LOGIC "1" INPUT

GENERAL DESCRIPTION

The ADG611, ADG612, and ADG613 are monolithic CMOS devices containing four independently selectable switches. These switches offer ultralow charge injection of 1 pC over full input signal range and typical leakage currents of 10 pA at 25°C .

They are fully specified for ± 5 V, +5 V, and +3 V supplies. They contain four independent single-pole/single-throw (SPST) switches. The ADG611 and ADG612 differ only in that the digital control logic is inverted. The ADG611 switches are turned on with a logic low on the appropriate control input, while a logic high is required to turn on the switches of the ADG612. The ADG613 contains two switches whose digital control logic is similar to the ADG611, while the logic is inverted on the other two switches.

Each switch conducts equally well in both directions when ON and has an input signal range that extends to the supplies. The ADG613 exhibits break-before-make switching action. The ADG611/ADG612/ADG613 are available in small 16-lead TSSOP packages.

PRODUCT HIGHLIGHTS

1. Ultralow Charge Injection (1 pC typically)
2. Dual ± 2.7 V to ± 5.5 V or Single +2.7 V to +5.5 V Operation.
3. Automotive Temperature Range, -40°C to $+125^{\circ}\text{C}$
4. Small 16-lead TSSOP package.

REV. 0

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ADG611/ADG612/ADG613—SPECIFICATIONS

DUAL SUPPLY¹ ($V_{DD} = +5\text{ V} \pm 10\%$, $V_{SS} = -5\text{ V} \pm 10\%$, $GND = 0\text{ V}$, unless otherwise noted.)

Parameter	Y Version			Unit	Test Conditions/Comments
	25°C	–40°C to +85°C	–40°C to +125°C		
ANALOG SWITCH					
Analog Signal Range	V _{SS} to V _{DD}			V	V _S = ±3 V, I _S = –1 mA Test Circuit 1
On-Resistance (R _{ON})	85			Ω typ	
	115	140	160	Ω max	
On-Resistance Match Between	2			Ω typ	V _S = ±3 V, I _S = –1 mA
Channels (ΔR _{ON})	4	5.5	6.5	Ω max	
On-Resistance Flatness (R _{FLAT(ON)})	25			Ω typ	V _S = ±3 V, I _S = –1 mA
	40	55	60	Ω max	
LEAKAGE CURRENTS					
Source OFF Leakage I _S (OFF)	±0.01			nA typ	V _{DD} = +5.5 V, V _{SS} = –5.5 V V _D = ±4.5 V, V _S = ∓4.5 V; Test Circuit 2
	±0.1	±0.25	±2	nA max	
Drain OFF Leakage I _D (OFF)	±0.01			nA typ	V _D = ±4.5 V, V _S = ∓4.5 V; Test Circuit 2
	±0.1	±0.25	±2	nA max	
Channel ON Leakage I _D , I _S (ON)	±0.01			nA typ	V _D = V _S = ±4.5 V, Test Circuit 3
	±0.1	±0.25	±6	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.4	V min	
Input Low Voltage, V _{INL}			0.8	V max	
Input Current					V _{IN} = V _{INL} or V _{INH}
I _{INL} or I _{INH}	0.005		±0.1	μA typ	
				μA max	
C _{IN} , Digital Input Capacitance	2			pF typ	
DYNAMIC CHARACTERISTICS ²					
t _{ON}	45			ns typ	R _L = 300 Ω, C _L = 35 pF V _S = 3.0 V, Test Circuit 4
	65	75	90	ns max	
t _{OFF}	25			ns typ	R _L = 300 Ω, C _L = 35 pF V _S = 3.0 V, Test Circuit 4
	40	45	50	ns max	
Break-Before-Make Time Delay, t _D	15			ns typ	R _L = 300 Ω, C _L = 35 pF V _{S1} = V _{S2} = 3.0 V, Test Circuit 5
			10	ns min	
Charge Injection	–0.5			pC typ	V _S = 0 V, R _S = 0 Ω, C _L = 1 nF, Test Circuit 6
Off Isolation	–65			dB typ	
Channel-to-Channel Crosstalk	–90			dB typ	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz, Test Circuit 7
–3 dB Bandwidth	680			MHz typ	
C _S (OFF)	5			pF typ	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz, Test Circuit 8
C _D (OFF)	5			pF typ	
C _D , C _S (ON)	5			pF typ	Test Circuit 9 f = 1 MHz f = 1 MHz f = 1 MHz
POWER REQUIREMENTS					
I _{DD}	0.001			μA typ	V _{DD} = +5.5 V, V _{SS} = –5.5 V Digital Inputs = 0 V or 5.5 V
			1.0	μA max	
I _{SS}	0.001			μA typ	Digital Inputs = 0 V or 5.5 V
			1.0	μA max	

NOTES

¹Temperature range is as follows. Y Version: –40°C to +125°C.

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

SINGLE SUPPLY¹ ($V_{DD} = 5\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $GND = 0\text{ V}$, unless otherwise noted.)

Parameter	Y Version			Unit	Test Conditions/Comments	
	25°C	–40°C to +85°C	–40°C to +125°C			
ANALOG SWITCH						
Analog Signal Range			0 V to V _{DD}	V	V _S = 3.5 V, I _S = –1 mA; Test Circuit 1 V _S = 3.5 V, I _S = –1 mA	
On-Resistance (R _{ON})	210			Ω typ		
	290	350	380	Ω max		
On-Resistance Match Between Channels (ΔR _{ON})	3			Ω typ		
	10	12	13	Ω max		
LEAKAGE CURRENTS						
Source OFF Leakage I _S (OFF)	±0.01			nA typ	V _{DD} = 5.5 V V _S = 1 V/4.5 V, V _D = 4.5 V/1 V; Test Circuit 2 V _S = 1 V/4.5 V, V _D = 4.5 V/1 V; Test Circuit 2 V _S = V _D = 1 V or 4.5 V, Test Circuit 3	
	±0.1	±0.25	±2	nA max		
Drain OFF Leakage I _D (OFF)	±0.01			nA typ		
	±0.1	±0.25	±2	nA max		
Channel ON Leakage I _D , I _S (ON)	±0.01			nA typ		
	±0.1	±0.25	±6	nA max		
DIGITAL INPUTS						
Input High Voltage, V _{INH}			2.4	V min		V _{IN} = V _{INL} or V _{INH}
Input Low Voltage, V _{INL}			0.8	V max		
Input Current						
I _{INL} or I _{INH}	0.005		±0.1	μA typ		
				μA max		
C _{IN} , Digital Input Capacitance ²	2			pF typ		
DYNAMIC CHARACTERISTICS ²						
t _{ON}	70			ns typ	R _L = 300 Ω, C _L = 35 pF V _S = 3.0 V, Test Circuit 4	
	100	130	150	ns max		
t _{OFF}	25			ns typ	R _L = 300 Ω, C _L = 35 pF V _S = 3.0 V, Test Circuit 4	
	40	45	50	ns max		
Break-Before-Make Time Delay, t _D	25			ns typ	R _L = 300 Ω, C _L = 35 pF V _{S1} = V _{S2} = 3.0 V, Test Circuit 5 V _S = 0 V, R _S = 0 Ω, C _L = 1 nF; Test Circuit 6	
			10	ns min		
Charge Injection	1			pC typ	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz Test Circuit 7	
Off Isolation	–62			dB typ		
Channel-to-Channel Crosstalk	–90			dB typ	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz Test Circuit 8	
–3 dB Bandwidth	680			MHz typ		
C _S (OFF)	5			pF typ	R _L = 50 Ω, C _L = 5 pF, Test Circuit 9 f = 1 MHz f = 1 MHz f = 1 MHz	
C _D (OFF)	5			pF typ		
C _D , C _S (ON)	5			pF typ		
POWER REQUIREMENTS						
I _{DD}	0.001		1.0	μA typ	V _{DD} = 5.5 V Digital Inputs = 0 V or 5.5 V	
				μA max		

NOTES

¹Temperature ranges are as follows. Y Version: –40°C to +125°C.²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

ADG611/ADG612/ADG613—SPECIFICATIONS

SINGLE SUPPLY¹ ($V_{DD} = 3\text{ V} \pm 10\%$, $V_{SS} = 0\text{ V}$, $GND = 0\text{ V}$, unless otherwise noted.)

Parameter	Y Version			Unit	Test Conditions/Comments
	25°C	–40°C to +85°C	–40°C to +125°C		
ANALOG SWITCH					
Analog Signal Range			0 V to V _{DD}	V	V _S = 1.5 V, I _S = –1 mA; Test Circuit 1
On-Resistance (R _{ON})	380	420	460	Ω typ	
LEAKAGE CURRENTS					
Source OFF Leakage I _S (OFF)	±0.01			nA typ	V _{DD} = 3.3 V V _S = 1 V/3 V, V _D = 3 V/1 V; Test Circuit 2
	±0.1	±0.25	±2	nA max	
Drain OFF Leakage I _D (OFF)	±0.01			nA typ	V _S = 1 V/3 V, V _D = 3 V/1 V; Test Circuit 2
	±0.1	±0.25	±2	nA max	
Channel ON Leakage I _D , I _S (ON)	±0.01			nA typ	V _S = V _D = 1 V or 3 V, Test Circuit 3
	±0.1	±0.25	±6	nA max	
DIGITAL INPUTS					
Input High Voltage, V _{INH}			2.0	V min	V _{IN} = V _{INL} or V _{INH}
Input Low Voltage, V _{INL}			0.8	V max	
Input Current					
I _{INL} or I _{INH}	0.005			μA typ	
			±0.1	μA max	
C _{IN} , Digital Input Capacitance	2			pF typ	
DYNAMIC CHARACTERISTICS ²					
t _{ON}	130			ns typ	R _L = 300 Ω, C _L = 35 pF V _S = 2 V, Test Circuit 4
	185	230	260	ns max	
t _{OFF}	40			ns typ	R _L = 300 Ω, C _L = 35 pF V _S = 2 V, Test Circuit 4
	55	60	65	ns max	
Break-Before-Make Time Delay, t _D	50			ns typ	R _L = 300 Ω, C _L = 35 pF V _{S1} = V _{S2} = 2 V, Test Circuit 5
			10	ns min	
Charge Injection	1.5			pC typ	V _S = 0 V, R _S = 0 Ω, C _L = 1 nF; Test Circuit 6
Off Isolation	–62			dB typ	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz Test Circuit 7
Channel-to-Channel Crosstalk	–90			dB typ	R _L = 50 Ω, C _L = 5 pF, f = 10 MHz Test Circuit 8
–3 dB Bandwidth	680			MHz typ	R _L = 50 Ω, C _L = 5 pF, Test Circuit 9
C _S (OFF)	5			pF typ	f = 1 MHz
C _D (OFF)	5			pF typ	f = 1 MHz
C _D , C _S (ON)	5			pF typ	f = 1 MHz
POWER REQUIREMENTS					
I _{DD}	0.001		1.0	μA typ μA max	V _{DD} = 3.3 V Digital Inputs = 0 V or 3.3 V

NOTES

¹Temperature ranges are as follows. Y Version: –40°C to +125°C.

²Guaranteed by design, not subject to production test.

Specifications subject to change without notice.

ADG611/ADG612/ADG613

ABSOLUTE MAXIMUM RATINGS¹

(T_A = 25°C unless otherwise noted)

V _{DD} to V _{SS}	13 V
V _{DD} to GND	−0.3 V to +6.5 V
V _{SS} to GND	+0.3 V to −6.5 V
Analog Inputs ²	V _{SS} − 0.3 V to V _{DD} + 0.3 V
Digital Inputs ²	GND − 0.3 V to V _{DD} + 0.3 V
Peak Current, S or D	20 mA (Pulsed at 1 ms, 10% Duty Cycle max)
Continuous Current, S or D	10 mA
3 V operation 85°C to 125°C	7.5 mA
Operating Temperature Range	
Automotive (Y Version)	−40°C to +125°C

Storage Temperature Range	−65°C to +150°C
Junction Temperature	150°C
16-Lead TSSOP, θ _{JA} Thermal Impedance	150.4°C/W
Lead Temperature, Soldering	
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C

NOTES

¹Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Only one absolute maximum rating may be applied at any one time.

²Overvoltages at IN, S, or D will be clamped by internal diodes. Current should be limited to the maximum ratings given.

ORDERING GUIDE

Model	Temperature Range	Package Description	Package Option
ADG611YRU	−40°C to +125°C	Thin Shrink Small Outline Package (TSSOP)	RU-16
ADG612YRU	−40°C to +125°C	Thin Shrink Small Outline Package (TSSOP)	RU-16
ADG613YRU	−40°C to +125°C	Thin Shrink Small Outline Package (TSSOP)	RU-16

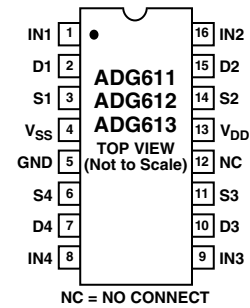
Table I. ADG611/ADG612 Truth Table

ADG611 In	ADG612 In	Switch Condition
0	1	ON
1	0	OFF

Table II. ADG613 Truth Table

Logic	Switch 1, 4	Switch 2, 3
0	OFF	ON
1	ON	OFF

PIN CONFIGURATIONS



CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the ADG611/ADG612/ADG613 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

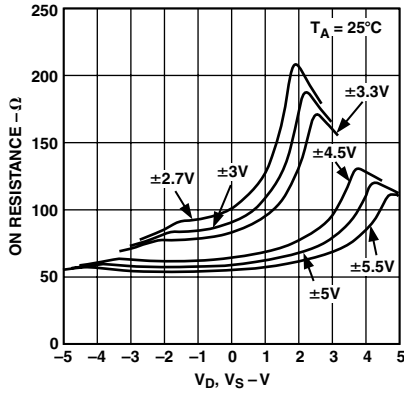


ADG611/ADG612/ADG613

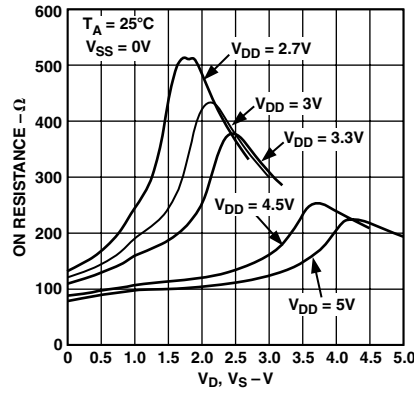
TERMINOLOGY

V_{DD}	Most Positive Power Supply Potential
V_{SS}	Most Negative Power Supply Potential
I_{DD}	Positive Supply Current
I_{SS}	Negative Supply Current
GND	Ground (0 V) Reference
S	Source Terminal. May be an input or output
D	Drain Terminal. May be an input or output
IN	Logic Control Input
$V_D (V_S)$	Analog Voltage on Terminals D, S
R_{ON}	Ohmic Resistance between D and S
ΔR_{ON}	On Resistance match between any two channels, i.e., $R_{ONMAX} - R_{ONMIN}$.
$R_{FLAT(ON)}$	Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal range.
I_S (OFF)	Source Leakage Current with the Switch “OFF”
I_D (OFF)	Drain Leakage Current with the Switch “OFF”
I_D, I_S (ON)	Channel Leakage Current with the Switch “ON”
V_{INL}	Maximum Input Voltage for Logic “0”
V_{INH}	Minimum Input Voltage for Logic “1”
$I_{INL}(I_{INH})$	Input Current of the Digital Input.
C_S (OFF)	“OFF” Switch Source Capacitance. Measured with reference to ground.
C_D (OFF)	“OFF” Switch Drain Capacitance. Measured with reference to ground.
C_D, C_S (ON)	“ON” Switch Capacitance. Measured with reference to ground.
C_{IN}	Digital Input Capacitance
t_{ON}	Delay between applying the digital control input and the output switching on. See Test Circuit 4.
t_{OFF}	Delay between applying the digital control input and the output switching off.
Charge Injection	A measure of the glitch impulse transferred from the digital input to the analog output during switching.
Off Isolation	A measure of unwanted signal coupling through an “OFF” switch.
Crosstalk	A measure of unwanted signal that is coupled through from one channel to another as a result of parasitic capacitance.
On Response	Frequency Response of the “ON” Switch
Insertion Loss	Loss Due to the ON Resistance of the Switch

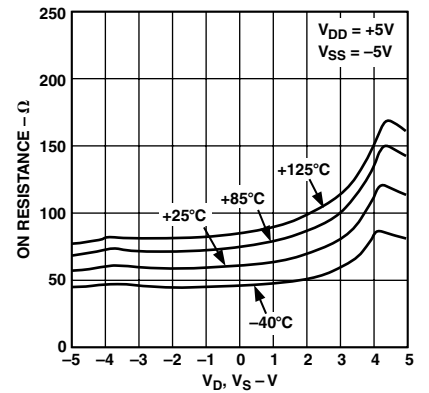
Typical Performance Characteristics—ADG611/ADG612/ADG613



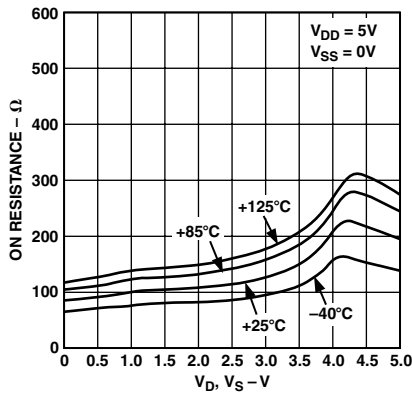
TPC 1. On Resistance vs. $V_D(V_S)$, Dual Supply



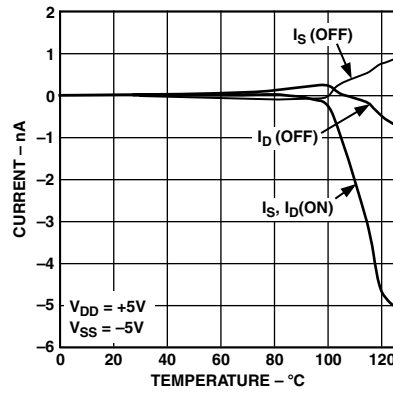
TPC 2. On Resistance vs. $V_D(V_S)$, Single Supply



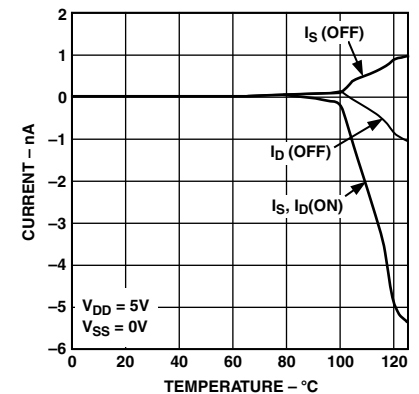
TPC 3. On Resistance vs. $V_D(V_S)$ for Different Temperatures, Dual Supply



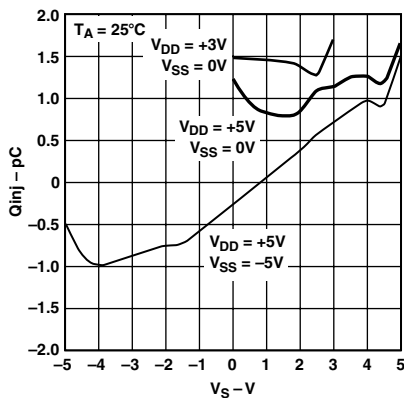
TPC 4. On Resistance vs. $V_D(V_S)$ for Different Temperatures, Single Supply



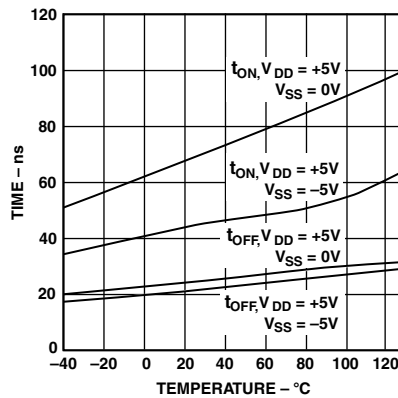
TPC 5. Leakage Currents vs. Temperature, Dual Supply



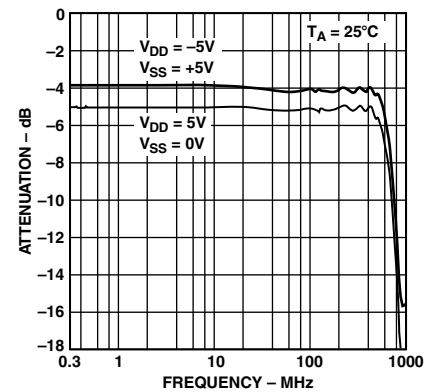
TPC 6. Leakage Currents vs. Temperature, Single Supply



TPC 7. Charge Injection vs. Source Voltage

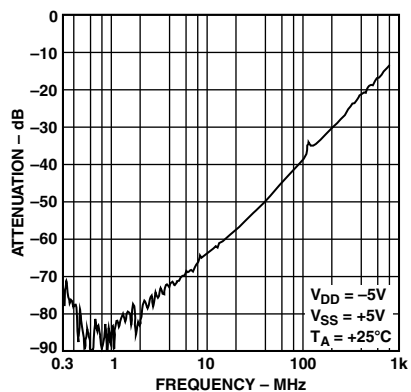


TPC 8. t_{ON}/t_{OFF} Times vs. Temperature

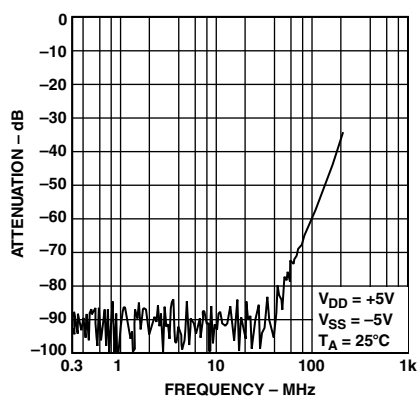


TPC 9. On Response vs. Frequency

ADG611/ADG612/ADG613



TPC 10. Off Isolation vs. Frequency



TPC 11. Crosstalk vs. Frequency

APPLICATIONS

Figure 1 illustrates a photodetector circuit with programmable gain. With the resistor values shown in the circuits, and using different combinations of switches, gains in the range of 2 to 16 can be achieved.

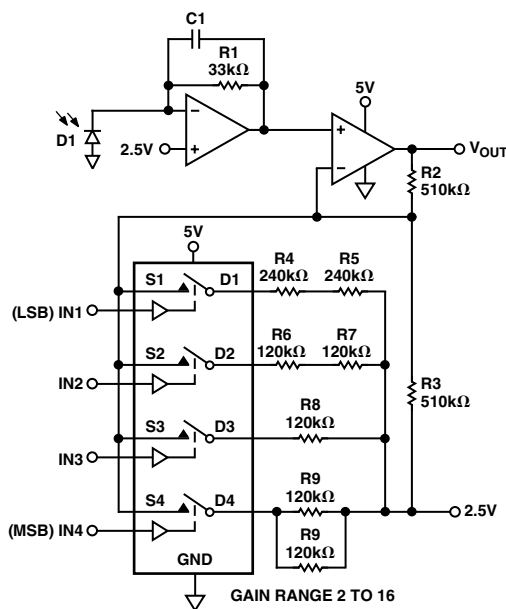
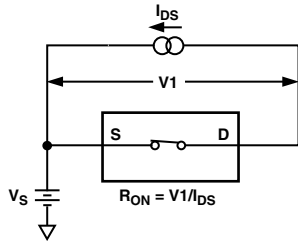
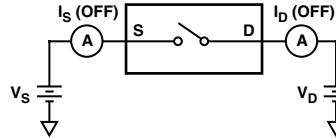


Figure 1. Photodetector Circuit with Programmable Gain

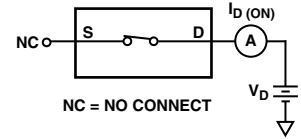
Test Circuits



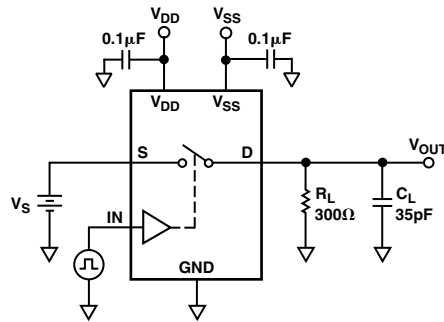
Test Circuit 1. On Resistance



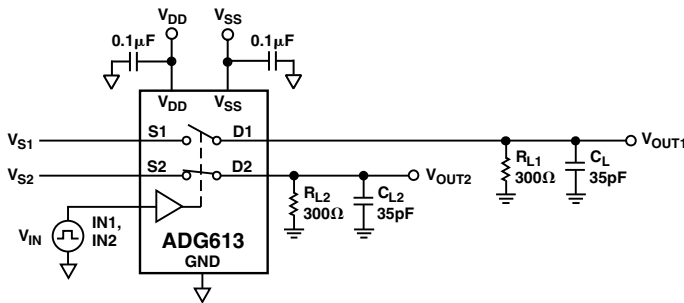
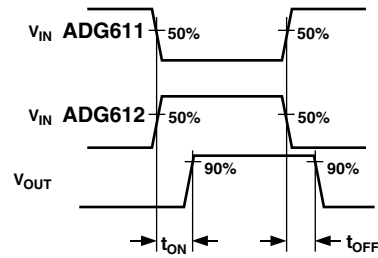
Test Circuit 2. Off Leakage



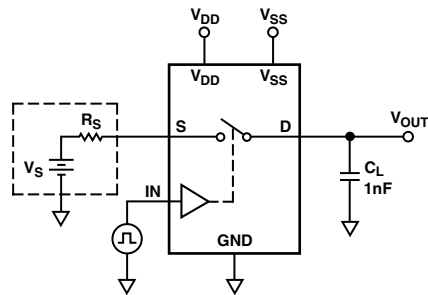
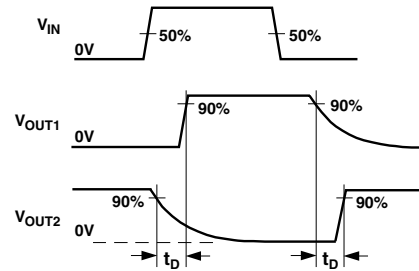
Test Circuit 3. On Leakage



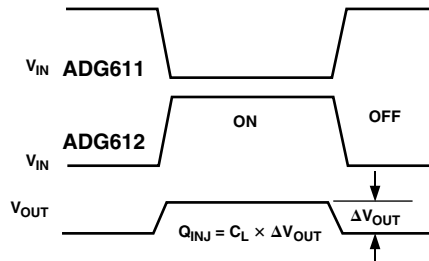
Test Circuit 4. Switching Times



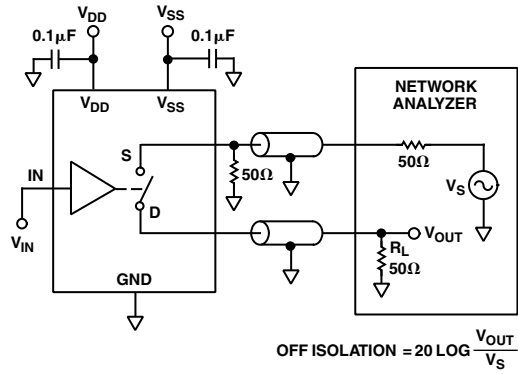
Test Circuit 5. Break-Before-Make Time Delay



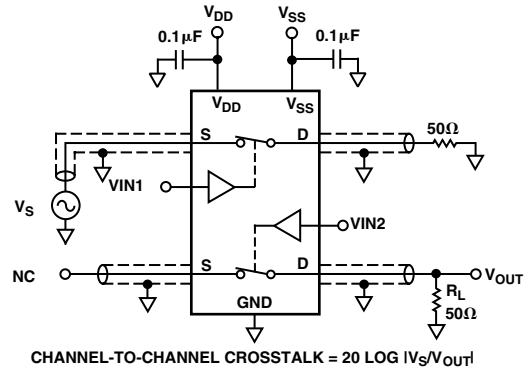
Test Circuit 6. Charge Injection



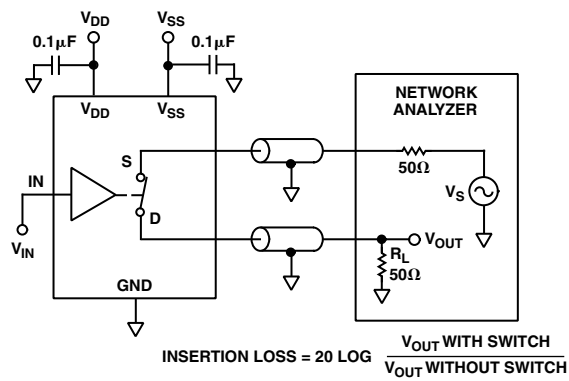
ADG611/ADG612/ADG613



Test Circuit 7. Off Isolation



Test Circuit 8. Channel-to-Channel Crosstalk



Test Circuit 9. Bandwidth

OUTLINE DIMENSIONS
Dimensions shown in inches and (mm).

16-Lead TSSOP
(RU-16)

